 **新應材獎學金申請表**

收件日期(由公司填寫) : 年 月 日

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| **基本資料** | | | | | | | |
| 姓 名 |  | 學 校 | |  | | 年 級 |  |
| 系 所 |  | 學 號 | |  | | 學 制 | □日間 □夜間 |
| 身份證字號 |  | 性 別 | | □男 □女 | | 出生年月日 | 年 月 日 |
| 聯絡電話 |  | | | 電子郵件 | |  | |
| 戶籍地址 |  | | | | | | |
| 通訊地址 |  | | | | | | |
| 是否領取公費及其他獎學金者 □是 □否 | | | | | | | |
| 職務排序: (1)\_\_\_\_\_\_\_\_、(2)\_\_\_\_\_\_\_\_ 、(3)\_\_\_\_\_\_\_\_。(研發/製程/品管工程師，至少填寫一職務) | | | | | | | |
| 工作地: (1)\_\_\_\_\_\_\_\_、(2)\_\_\_\_\_\_\_\_ 、(3)\_\_\_\_\_\_\_\_。(桃園廠/台南廠/高雄廠，至少填寫一工作地) | | | | | | | |
| **學歷背景** | | | | | | | |
| 教育程度 | 學校名稱 | | 主修科系 | | 起迄年月 | | |
| 大學 |  | |  | | ~ | | |
| 高中 |  | |  | | ~ | | |
| **檢附文件資料** | | | | | | | |
| □新應材獎學金申請表(本表)。 | | | | | | | |
| □成績單正本(依新應材獎學金實施辦法規定提供)。 | | | | | | | |
| □履歷、自傳(300~500字,含未來展望。) | | | | | | | |
| □學生證影本。 | | | | | | | |
| □身分證正反面影本。 | | | | | | | |
| □教授推薦信。(非必要項目) | | | | | | | |
| □加分項目:其他有利於審查之文件。 (各類技能及語文檢定、專題研究、期刊論文、相關證照) | | | | | | | |
| **個人資料蒐集告知聲明同意書** | | | | | | | |
| 一、本人已詳讀新應材獎學金實施辦法各項說明及填寫相關內容，保證以上填寫資料均屬事實。  二、本人同意新應材基於獎學金申請之目的得對本人所提供之個人資料加以蒐集、處理及利用，獲獎者之學校系所及姓名將公佈於新應材公司官網；亦明瞭本人依法有向新應材請求查詢、閱覽、複製、補充、更正、刪除或請求停止蒐集、處理、利用個人資料之權，未獲獎者申請資料將保留至申請年年底以密件刪除、銷毀。  三、本同意書如有未盡事宜，本公司將依個人資料保護法或其他相關法規及其後修訂之規定辦理。  □您瞭解此一同意書符合個人資料保護法及相關法規之要求，且瞭解其內容，並同意本同意書所列之事項。  本人簽名：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_  日期：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ | | | | | | | |

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| **成績單正本** |
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| **成績單正本** |
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| **履歷** |
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| **自傳(300~500字,含未來展望。)** |
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| **身分證** | |
| 正面 | 反面 |
| **學生證** | |
| 正面 | 反面 |
| **加分項目:其他有利於審查之文件。 (各類技能及語文檢定、專題研究、期刊論文、相關證照)** | |
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| **加分項目:其他有利於審查之文件。 (各類技能及語文檢定、專題研究、期刊論文、相關證照)** |
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一張含有 文字, 標誌, 字型, 圖形 的圖片

自動產生的描述 **AEMC Scholarship Application Form**

Date of Receipt (To be filled out by the Company): Y M D

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| --- | --- | --- | --- | --- | --- | --- | --- |
| **Basic Information** | | | | | | | |
| Name |  | School | |  | | Grade |  |
| Degree/Major |  | Student ID Number | |  | | Program Type | □Day School  □Night School |
| Passport No. |  | Gender | | □Male  □Female | | Date  of Birth | Y M D |
| Mobile Phone |  | | | Email Address | |  | |
| Nationality |  | | | | | | |
| Present Address |  | | | | | | |
| Language skills: English : □ basic level、□ intermediate level、□ advanced level  Mandarin Chinese : □ basic level、□ intermediate level、□ advanced level Other\_\_\_\_\_\_\_\_\_ : □ basic level、□ intermediate level、□ advanced level | | | | | | | |
| Job ranking: (1) \_\_\_\_\_\_ (2) \_\_\_\_\_\_ (3) \_\_\_\_\_\_ (Please list at least one position: R&D/EN/QC Engineer) | | | | | | | |
| Location: (1) \_\_\_\_\_ (2) \_\_\_\_\_ (3) \_\_\_\_\_ (Please list at least one location: Taoyuan/Tainan/Kaohsiung) | | | | | | | |
| **Education** | | | | | | | |
| Education | Name of School | | Degree/Major | | From and To | | |
| University |  | |  | | ~ | | |
| High School |  | |  | | ~ | | |
| **Attached Supporting Documents** | | | | | | | |
| □AEMC Scholarship Application Form | | | | | | | |
| □Official transcript (Provided in accordance with AEMC’s Scholarship Application Guidelines)。 | | | | | | | |
| □Resume and autobiography (300-500 words, including future goals). | | | | | | | |
| □Photocopy of the student ID card. | | | | | | | |
| □Photocopy of both sides of the ID card. | | | | | | | |
| □A professor's recommendation letter. | | | | | | | |
| □Supplementary documents: Additional documents supporting the review (certificates highlighting skills and language proficiency, research projects, journal papers, and other related certifications) | | | | | | | |
| **Personal Data Collection Consent Form** | | | | | | | |
| 1. I have read the explanations and completed the relevant sections of AEMC’s Scholarship Application Guidelines, and I confirm that the information I have provided above is factual.  2. I agree that AEMC may collect, process, and use the personal information I provided for the purpose of the scholarship application. Scholarship recipients’ names and departments will be published on AEMC's official website. I understand that, by law, I have the right to request access, review, copy, supplement, correct, delete, or stop the collection, processing, and use of my personal information. Application materials from non-recipients will be treated as confidential and retained until the end of the application year before being deleted and destroyed.  3. For matters not covered in this agreement, the Company will act in accordance with the Personal Data Protection Act or other relevant laws and their subsequent revisions. □You understand that this agreement complies with the requirements of the Personal Data Protection Act and related regulations. I also comprehend its content and consent to the matters listed in this agreement.  Applicant Signature:\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_  Date:\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ | | | | | | | |

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| **Official transcript** |
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| **Official transcript** |
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| **Resume** |
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| **Autobiography (300-500 words, including future goals)** |
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| --- | --- |
| **ID card** | |
| **Front Side** | **Reverse Side** |
| **Student ID card.** | |
| **Front Side** | **Reverse Side** |
| **Supplementary documents: Additional documents supporting the review (certificates highlighting skills and language proficiency, research projects, journal papers, and other related certifications)** | |
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| **Supplementary documents: Additional documents supporting the review (certificates highlighting skills and language proficiency, research projects, journal papers, and other related certifications)** |
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